© Co	t erial Composit i opyright 2005. IPC, E national and Pan-Am	annockbi	urn, Illinois. A	ll rights reserved utions.	under both	This docume level parts, t	ent is a declarat he declaration o	ion of the su encompasse	ubstances v s all lower	within the manufacture level materials for w	urer listed which the	tem. Note: nanufacture	if the item is an as r has engineering	sembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				e *	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information				
Supplier Information															
Company name*			Company uni	Company unique ID			Unique ID Authority				Respon	Response Date*			
onsemi											2024-05	2024-05-16			
Contact Name Ti			Title - Contact				Phone - Contact*				Email -	Email - Contact*			
Product-Env-Stewards P			Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title			Title - Repres	Title - Representative			Phone - Representative*			Email -	Email - Representative*				
Product-Env-Stewards Pro			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com				
Requester Item N	lester Item Number Mfr Item		n Number Mfr Item Name				Effective Date Version		N	Manufacturing Site		Weight*	UOM	Unit Type	
		FOD050LR2 S		SO8 3.3V 1MB TR T&R			2024-05-16		Т	ТНН		135.043	mg	Each	
Anufacturing Procee	ess Information														
Terminal Plating / Grid Array Material Termina		erminal Base A	al Base Alloy J-STD-020 MSL		L Rating	Peak Process Body Temperatu		emperature	ure Max Time at Peak Tempe		ture Num	ber of Reflow Cyc	les		
Matte Tin (Sn) - annealed C		J Alloy 1			260 C		С	30 seco		seconds 3					
omments															
vel 1 - maximum time at p	oeak temperature d	uring sole	dering is 10-3) seconds											
or more information rega	rding material com	position p	olease refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	4.043	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.283	mg
			Supplier	Silicon (Si)	7440-21-3		3.76	mg
Die Attach	0.25	mg		Hardener	proprietary data		0.0125	mg
			Supplier	Silver (Ag)	7440-22-4		0.2188	mg
			Supplier	Dicyandiamine	461-58-5		0.0012	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.0175	mg
Lead Frame	28.246	mg	Supplier	Zinc (Zn)	7440-66-6		0.0339	mg
			Supplier	Iron (Fe)	7439-89-6		0.6638	mg
			Supplier	Copper (Cu)	7440-50-8		27.5399	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0085	mg
Mold Compound-White	92.49	mg		Epoxy resin	proprietary data		12.4861	mg
			Supplier	Phenol Resin	Proprietary Data		5.0869	mg
			Supplier	Titanium Dioxide (TiO2)	13463-67-7		23.1225	mg
			В	Brominated Bisphenol A Diglycidyl Ether	40039-93-8		2.7747	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		2.7747	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		46.245	mg
Plating	0.554	mg	Supplier	Silver (Ag)	7440-22-4		0.0085	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0198	mg
			В	Nickel (Ni)	7440-02-0		0.5144	mg
			Supplier	Gold (Au)	7440-57-5		0.0113	mg
Protective Coating	9.1	mg	Supplier	Poly(dimethylsiloxane), hydroxy terminated	70131-67-8		4.55	mg
			Supplier	Ethylbenzene	100-41-4		0.91	mg
			Supplier	Filler (SiO2)	68909-20-6		1.729	mg
			Supplier	Misc.	Proprietary Data		0.091	mg
			Supplier	Xylene	1330-20-7		1.82	mg
Wire Bond - Au	0.36	mg	Supplier	Gold (Au)	7440-57-5		0.36	mg